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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR .	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/648,586	08/26/2003	Efren M. Lacap	408204	4089
30955	7590 06/23/2005		EXAMINER	
LATHROP & GAGE LC 4845 PEARL EAST CIRCLE		JOHNSON, JONATH		ONATHAN J
SUITE 300	LAGI CIRCLE		ART UNIT	PAPER NUMBER
BOULDER, (CO 80301		1725	

DATE MAILED: 06/23/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
	10/648,586	LACAP ET AL.				
Office Action Summary	Examiner	Art Unit				
	Jonathan Johnson	1725				
The MAILING DATE of this communicate Period for Reply	tion appears on the cover sheet wi	th the correspondence address				
A SHORTENED STATUTORY PERIOD FOR	REPLY IS SET TO EXPIRE 3 MG	ONTH(S) FROM				
THE MAILING DATE OF THIS COMMUNICA - Extensions of time may be available under the provisions of 3' after SIX (6) MONTHS from the mailing date of this communic - If the period for reply specified above is less than thirty (30) dated in the period for reply is specified above, the maximum statuto - Failure to reply within the set or extended period for reply will, Any reply received by the Office later than three months after earned patent term adjustment. See 37 CFR 1.704(b).	TION. 7 CFR 1.136(a). In no event, however, may a reation. 19s, a reply within the statutory minimum of thirty period will apply and will expire SIX (6) MON by statute. cause the application to become AB	eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).				
Status						
1)⊠ Responsive to communication(s) filed o	n <u>4-25-05</u> .					
•——	This action is non-final.					
3) Since this application is in condition for	allowance except for formal matte	ers, prosecution as to the merits is				
closed in accordance with the practice	under <i>Ex par</i> te <i>Quayle</i> , 1935 C.D	. 11, 453 O.G. 213.				
Disposition of Claims						
4)⊠ Claim(s) <u>1-17</u> is/are pending in the app	lication.					
4a) Of the above claim(s) <u>12-17</u> is/are w						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1-11</u> is/are rejected.						
7) Claim(s) is/are objected to.						
8) Claim(s) <u>1-17</u> are subject to restriction	and/or election requirement.					
Application Papers						
9)☐ The specification is objected to by the E	xaminer.					
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.						
Applicant may not request that any objectio						
Replacement drawing sheet(s) including the						
11)☐ The oath or declaration is objected to by	the Examiner. Note the attached	Office Action or form PTO-152.				
Priority under 35 U.S.C. § 119						
12)☐ Acknowledgment is made of a claim for	foreign priority under 35 U.S.C. §	119(a)-(d) or (f).				
a) ☐ All b) ☐ Some * c) ☐ None of:						
 Certified copies of the priority do 						
2. Certified copies of the priority do						
3. Copies of the certified copies of the		received in this National Stage				
application from the International		roppiyad				
* See the attached detailed Office action for	or a list of the certified copies not	received.				
Attachment(s)						
1) Notice of References Cited (PTO-892)	·	Summary (PTO-413)				
 2) Notice of Draftsperson's Patent Drawing Review (PTO-3) Information Disclosure Statement(s) (PTO-1449 or PTO-1449) 	<u> </u>	s)/Mail Date nformal Patent Application (PTO-152)				
Paper No(s)/Mail Date <u>8-26-03</u> .	6) Other:	· · · · · · · · · · · · · · · · · · ·				
U.S. Patent and Trademark Office PTOL-326 (Rev. 1-04)	Office Action Summary	Part of Paper No./Mail Date 061805	70			

Application/Control Number: 10/648,586

Art Unit: 1725

DETAILED ACTION

Election/Restrictions

Applicant's arguments are persuasive. The examiner will merge group 1a and 1b.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.

Claims 1-11 are rejected under 35 U.S.C. 102(a) as being anticipated by Applicant's Admitted Prior Art (AAPA). AAPA teaches forming a socket on a first surface of a microchip, such that the socket has predetermined physical dimensions complementary to those of a microchip connection pad footprint occupied by at least one contact pad area on the microchip (fig. 2, item 29), the socket presenting a conductive base capable of bonding to solder; bonding solder to the conductive base to place a solder bar in the socket and place the microchip in made-ready condition for installation. (fig. 2, item 3a); wherein the microchip contains a silicon wafer and the step of forming the socket comprises depositing an adhesion layer onto the wafer, and depositing underbump-metallization (UBM) material contacting the adhesion layer to complete formation of the conductive base (figure 2, items 4, 28 and 29); wherein the step of depositing the adhesion layer includes depositing a conductor selected from the group consisting of aluminum, nickel-vanadium, titanium, tungsten and copper (specification, paragraph 7);

Application/Control Number: 10/648,586

Art Unit: 1725

wherein the step of depositing the UMB material includes depositing a conductor selected from at least one of titanium, tungsten, vanadium, tin, copper, aluminum, gold, silver, and lead (specification, paragraph 8); wherein the step of forming the socket includes the predetermined dimensions selected from the group consisting of rectangular, "E," "L," and "U" shapes (figure 2, side profile of item 29); wherein the step of forming the socket includes the physical dimensions selected from the group consisting of ring, square, and circular shapes (figure 2, top view of item 20a); , wherein the step of forming the socket includes the physical dimensions being complimentary to the solder bar having a planar rectilinear configuration (figure 2, side view of 20A); wherein the step of forming the socket includes the physical dimensions being complimentary to the solder bar having a planar curvilinear configuration (figure 2, top view of 20a); wherein the step of forming the socket includes the physical dimensions being complimentary to the solder bar having a planar curvilinear configuration (figure 2, item 3a); wherein the step of forming the socket further comprising a step of forming a passivation layer on substantially all of the first surface, exclusive of an area where the socket is located (figure 2, item 29); wherein the step of forming the passivation layer includes the steps of: applying one or more layers of passivation material to the entire first surface; and removing selected portions of the passivation material covering the area where the socket is to be located (figure 2, item 29); wherein the step of applying one or more layers of passivation material includes applying at least one layer selected from the group consisting of polysilicon, silicon dioxide, and benzocyclobutane (figure 2, item 28).

Application/Control Number: 10/648,586

Art Unit: 1725

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jonathan Johnson whose telephone number is 571-272-1177. The examiner can normally be reached on M-Th 7:30 AM-5:30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Dunn can be reached on 571-272-1171. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jonathan Johnson Primary Examiner Art Unit 1725